

ABSTRACT OF THE DISCLOSURE

FLUID EJECTION DEVICE METAL LAYER LAYOUTS

A fluid ejection device comprises a first metal layer 1 and a second metal layer 11. The first metal layer 1 comprises an address path portion 6 and a non-address path portion 2, 3, 4, 5. The second metal layer 11, which overlies the first metal layer 1, comprises a first portion 7 which comprises a power conducting portion 7. The power conducting portion 7 is routed only over the non-address path portion 2, 3, 4, 5 of the first metal layer 1.

(FIG. 1)